

#### **Product Summary**

Device	V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
01	<u> </u>	1.7Ω @ V <sub>GS</sub> = 10V	500mA
Q1	60V	3Ω @ V <sub>GS</sub> = 4.5V	400mA
	001/	4Ω @ V <sub>GS</sub> = -10V	-360mA
Q2 -6	-60V	6Ω @ V <sub>GS</sub> = -4.5V	-310mA

### **Description and Applications**

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- General-purpose interfacing switches
- Power management functions
- Analog switches



Top View

Bottom View

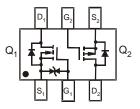
#### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG1029SVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish—Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3)
- Weight: 0.027 grams (approximate)



#### Ordering Information (Note 4)

Part Number	Compliance	Baakaga	Pa	acking
Fait Nulliper	Compliance	Package -	Qty.	Carrier
DMG1029SVQ-7	Automotive	SOT563	3000	Tape & Reel
DMG1029SVQ-7A	Automotive	SOT563	3000	Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

### **Marking Information**

Γ		$\square$			
	GA	1	YI	М	
•					

GA1 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: J = 2022) M = Month (ex: 9 = September)

Notes:

Dale Code Key												
Year	2009		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	W		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	0	0		-	<u>^</u>	7	0	0	0	N	<b>D</b>

The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries.



#### Maximum Ratings N-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage		V <sub>DSS</sub>	60	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
Continuous Drain Current (Note 6) \/ 10\/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	500 400	mA
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	620 480	mA
Maximum Body Diode Forward Current (Note 6)			IS	500	mA
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	1000	mA		
Pulsed Source Current (Note 6)		I <sub>SM</sub>	1000	mA	

## Maximum Ratings P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage		V <sub>DSS</sub>	-60	V	
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$		ID	-360 -280	mA	
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	-410 -320	mA
Maximum Body Diode Forward Current (Note 6)			ls	-360	mA
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	-650	mA		
Pulsed Source Current (Note 6)	I <sub>SM</sub>	-650	mA		

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Dower Dissipation (Nata 5)	T <sub>A</sub> = +25°C	D	0.45	W
Total Power Dissipation (Note 5)	T <sub>A</sub> = +70°C	PD	0.28	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	P	281	°C/W
Thermal Resistance, Sunction to Ambient (Note 3)	t<10s	$R_{ heta}$ JA	210	0/00
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1	W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +70°C	۳D	0.62	vv
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	129	°C/W
	t<10s	$R_{ heta JA}$	97	0/22
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



## Electrical Characteristics N-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Cumulant	Min	Ture	Max	11	Test Condition
	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						1
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60			V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	I <sub>DSS</sub>	—	—	10	nA	$V_{DS}$ =50V, $V_{GS}$ = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_		±50	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	_	2.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	D	_	1.3	1.7	Ω	$V_{GS} = 10V, I_D = 500mA$
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	_	1.5	3	1	$V_{GS} = 4.5 V, I_D = 200 mA$
Forward Transfer Admittance	Y <sub>fs</sub>	80	_	_	mS	$V_{DS} = 10V, I_D = 200mA$
Diode Forward Voltage	V <sub>SD</sub>	_	—	1.4	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	30		pF	
Output Capacitance	Coss	_	4.2	—	pF	V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.9	_	pF	1 = 1.000112
Total Gate Charge	Qg	_	0.3		nC	
Gate-Source Charge	Q <sub>gs</sub>	_	0.2		nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q <sub>gd</sub>	_	0.08		nC	$I_D = 250 \text{mA}$
Turn-On Delay Time	t <sub>D(on)</sub>	_	3.9	—	ns	
Turn-On Rise Time	tr	_	3.4	—	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	_	15.7	—	ns	$R_{G} = 25\Omega, I_{D} = 200 \text{mA}$
Turn-Off Fall Time	t <sub>f</sub>	_	9.9	_	ns	1

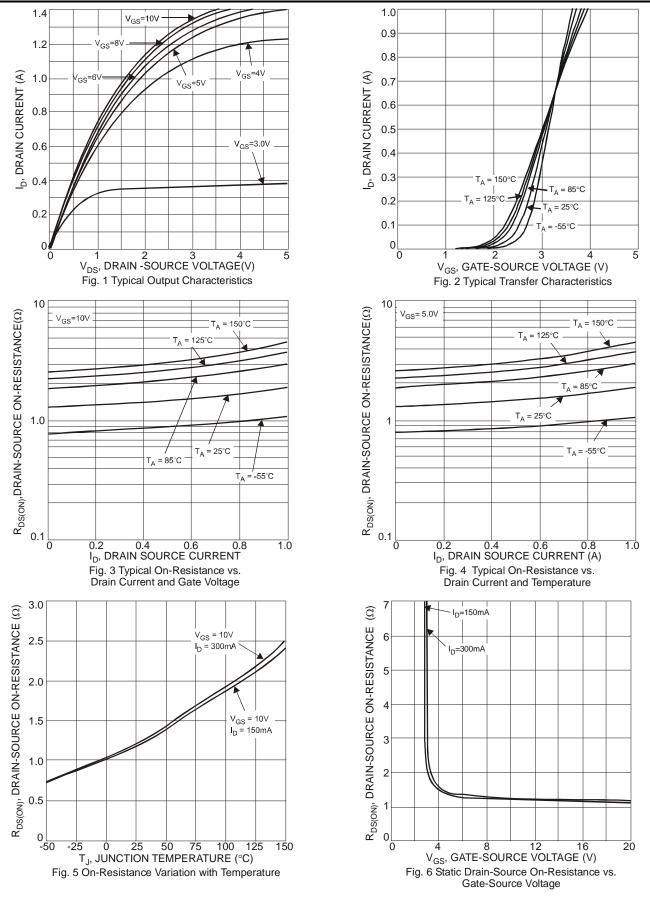
# Electrical Characteristics P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-60	—	—	V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	I <sub>DSS</sub>	_	—	-25	nA	$V_{DS} = -50V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	_	—	±100	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1	—	-3.0	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
Static Drain-Source On-Resistance	D	_	2.7	4	Ω	$V_{GS} = -10V, I_D = -500mA$
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>	_	3.2	6		$V_{GS} = -4.5V, I_D = -200mA$
Forward Transfer Admittance	Y <sub>fs</sub>	50	—	—	mS	$V_{DS} = -25V, I_D = -100mA$
Diode Forward Voltage	V <sub>SD</sub>	_	—	-1.4	V	$V_{GS} = 0V, I_{S} = -115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	25	—	pF	
Output Capacitance	Coss	—	4.7	—	pF	$V_{DS} = -25V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.7	—	pF	
Total Gate Charge	Qg	_	0.28	—	nC	
Gate-Source Charge	Q <sub>gs</sub>	_	0.14	—	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$
Gate-Drain Charge	Q <sub>gd</sub>	_	0.08	_	nC	$-I_{D} = -500 \text{mA}$
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.5	_	ns	
Turn-On Rise Time	tr		7.9	_	ns	V <sub>DD</sub> = -30V, V <sub>GS</sub> = -10V,
Turn-Off Delay Time	t <sub>D(off)</sub>		10.6	—	ns	$R_{G} = 50\Omega, I_{D} = -270 \text{mA}$
Turn-Off Fall Time	t <sub>f</sub>	_	11.6	_	ns	7

Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.

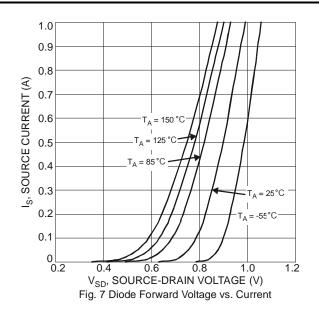


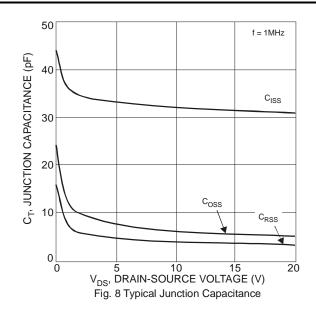
### N-CHANNEL - Q1





### N-CHANNEL - Q1 (continued)

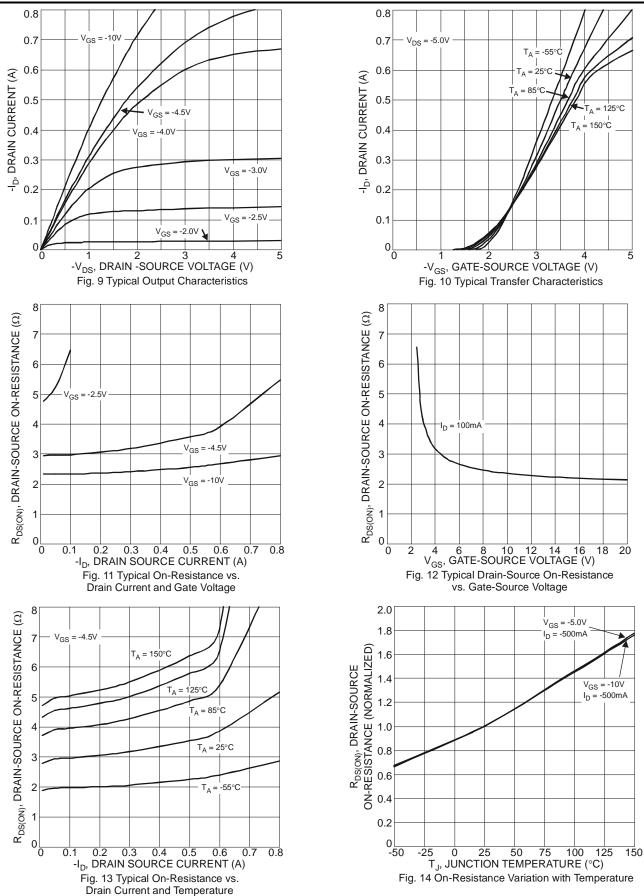






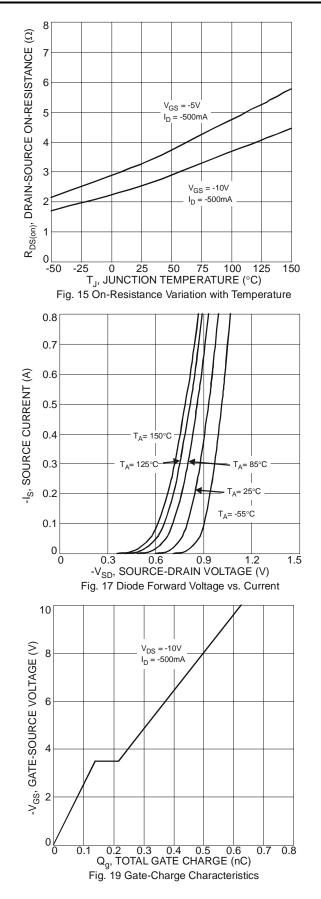
# DMG1029SVQ

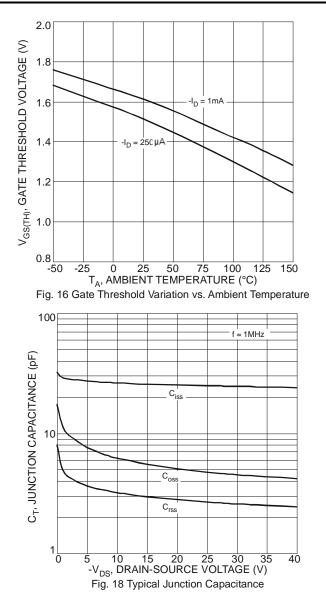






#### P-CHANNEL – Q2 (continued)

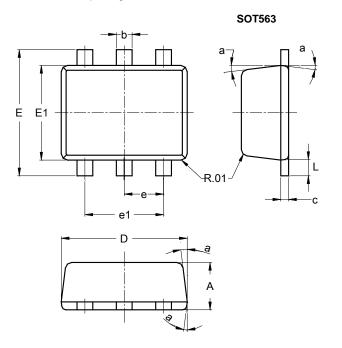






#### **Package Outline Dimensions**

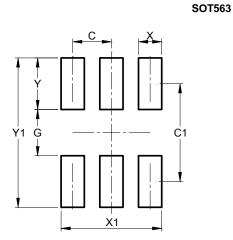
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60					
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All	Dimens	sions in	mm				

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



 Dimensions
 Value (in mm)

 C
 0.500

 C1
 1.270

 G
 0.600

 X
 0.300

 X1
 1.300

 Y
 0.670

 Y1
 1.940



#### IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5. products provided subject to Diodes' Standard Terms and Conditions of Sale Diodes are (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2022 Diodes Incorporated

#### www.diodes.com

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达迩科技(美台))